Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	6975	solder$4 and insulat$4 near (case or casing or housing) and terminal	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 13:23
L2	4421	1 and (slot or slit or groove or channel)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 13:24
L3	4109	2 and (contact or pad or electrode)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 13:25
L4	533	3 and (contact or pad or electrode)near solder$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 13:17
L5	108	4 and tip	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 13:25
L6	2	4 and implant$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 13:25
L7	178	4 and (metal or metal$4) near (plate or sheet or foil)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 13:25
L8	1	7 and ((metal or metal$4) near (plate or sheet or foil)) near embed$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 13:24

L9	13	4 and (pinhole or pin adj hole or "pin-hole")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 13:25
L10	2	4 and solder$4 near (sheet or foil)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 13:25
L11	37	5 and (bump$4 or ball)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 13:21
L12	1216	(228/180.1).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/30 13:23
L13	12	L12 and solder$4 and insulat$4 near (case or casing or housing) and terminal	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 13:23
L14	4	13 and (slot or slit or groove or channel)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 13:25
L15	4	14 and (contact or pad or electrode)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 13:25
L16	2	15 and tip	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 13:25

L17	1	15 and implant$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 13:25
L18	2	15 and (metal or metal$4) near (plate or sheet or foil)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 13:25
L19	1	15 and solder$4 near (sheet or foil)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 13:25
L20	1	15 and (pinhole or pin adj hole or "pin-hole")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 13:26